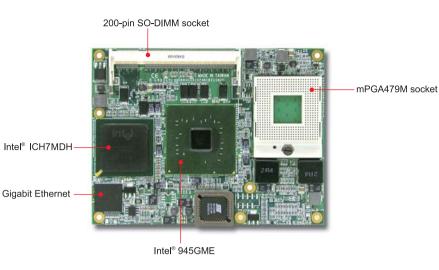
PCOM-B211VG





Active Heat Sink



Passive Heat Sink

FEATURES

- Intel[®] 945GME based module supports Core Solo or Core Duo processors
- Accept both Intel[®] socket type and BGA type processors for intensive computing power or fan-less applications
- Plug-n-run with the carrier boards and speeds up time-to market
- SATA interface to support faster transfer rate in storage devices
- Maximum 2GB DDR2 memory

GENERAL	
Processor	CPU & Package: Intel [©] Core [™] Duo or Solo processor in FCPGA-478 package FSB: 667/533MHz
Chipset/Core Logic	Intel® 945GME and ICH7MDH
System Memory	Up to 2GB DDR2 667/533/400 SDRAM on one 200-pin DIMM socket
BIOS	Award BIOS
Storage Devices	EIDE: Support one EIDE channel with Ultra DMA 100/66/33 SATA: Support Two SATA 150 drives
Solid State Disk	N/A
Watchdog Timer	N/A
Expansion Interface	 One PCI Express x16, multiplexed with SDVO interface Five PCI Express x1 Four PCI devices LPC interface High definition audio interface
Hardware Monitoring	CPU temperature
Dimension	Dimension : 125(L) x 95(W) mm; 4.9"(L) x 3.7" (W)
Environment	Operating Temperature: 0 to 60°C Storage Temperature: -20 to 80°C Relative Humidity: 5% to 90%, non-condensing

ORDERING GUIDE

Standard	PCOM-B211VG Intel [®] Core [™] Duo or Solo processor based Type II COM Express module with DDR2 SDRAM, VGA, Gigabit Ethernet and USB
Optional	Active Heat Sink Heat sink for both PCOM-210/211 with socket type processor
	Passive Heat Sink Heat sink for both PCOM-210/211 with low power consumption on-board processor

1/0	
MIO	N/A
IrDA	N/A
Ethernet	One Gigabit Ethernet (Intel® PC82573L)
Audio	N/A
USB	USB 2.0 x 8
Keyboard & Mouse	N/A

DISPLAY	
Graphic Controller	Intel® 945GME integrated Intel® Graphics Media Accelerator 950 (Intel® GMA 950)
Graphic Memory	Dynamic share system memory up to 224MB (Intel^ DVMT 3.0) or static share system memory up to 128MB
Display Interface	- Support CRT, LVDS and TV-out display interfaces - CRT display resolution QXGA